DISPLAY Elektronik GmbH

DATA SHEET

LCD MODULE

DEM 16102 SYH-LY

Product Specification

Version: 2

GENERAL SPECIFICATION

MODULE NO.:

DEM 16102 SYH-LY

CUSTOMER P/N

VERSION NO.	CHANGE DESCRIPTION	DATE
0	ORIGINAL VERSION	14.02.2001
1	CHANGE IC	17.02.2008
2	CHANGE PCB DESCRIPTION	02.02.2009

PREPARED BY: CC DATE: 02.02.2009

APPROVED BY: MH DATE: 02.02.2009

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1.FUNCTIONS & FEATURES

MODULE NAME	LCD TYPE
DEM 16102 SYH-LY	STN Yellow Green Transflective Positive Mode

Viewing Direction : 6 o'clock

Driving Scheme : 1/16 Duty Cycle, 1/5 Bias

Power Supply Voltage : 5 Volt (typ.) $V_{LCD}(VDD-V0)$: 4.5 Volt (typ.)

Display content : 16 x 1Characters (5x8 dots, Format: 208 Kids)

Internal Memory : CGROM (10,080 bits)

> : CGRAM (64 x 8 bits) : DDRAM (80 x 8 bits for Digits)

: CGROM of the ST7066U-0A-B (Sitronix)

CGROM Interface : Easy Interface with a 4-bit or 8-bit MPU

Operating Temperature : -20° C to $+70^{\circ}$ C : -30° C to $+80^{\circ}$ C Storage Temperature

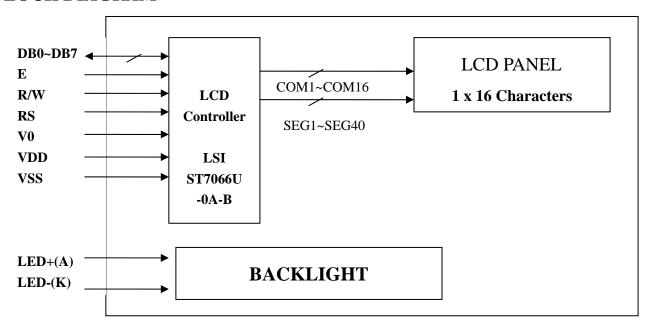
2. MECHANICAL SPECIFICATIONS

Module Size : 80.00 x 36.00 x 12.40 mm

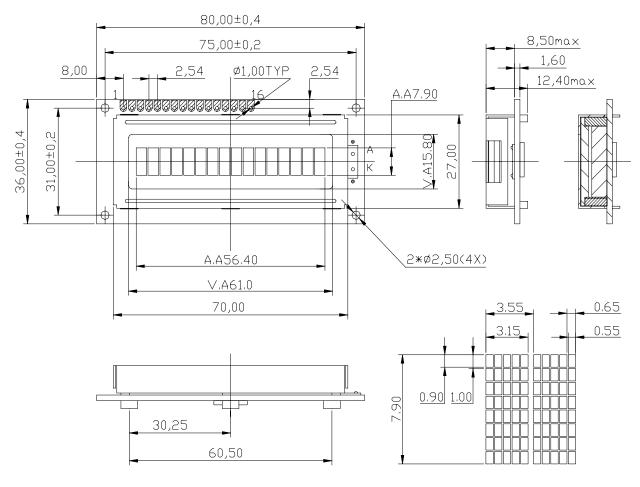
Character Pitch : 3.55 x 7.90 mm Character Size : 3.15 x 7.9 mm **Character Font** : 5 x 8 dots Dot Pitch : 0.65 x 1.00 mm Dot Size : 0.55 x 0.90 mm

Dot Gap : 0.10 x 0.10 mm

3. BLOCK DIAGRAM



4. EXTERNAL DIMENSIONS

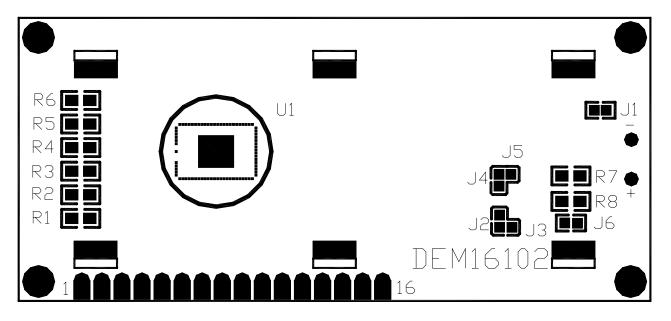


UNLESS TOLERANCE IS ±0.3

5. PIN ASSIGNMENT

Pin No.	Symbol	Function							
1	Vss	Ground terminal of module							
2	VDD	Supply terminal of module +5V							
3	V_0	Power Supply for Liquid Crystal Drive							
4	RS	Select Display Data ("1") or Instructions ("0")							
5	R/W	Read or Write: R/W=1 Read, R/W=0 Write							
6	Е	Enable							
7	DB0								
8	DB1								
9	DB2	Bi-directional Data Bus, Data Transfer is performed is once,							
10	DB3	thru DB0~DB7, in the case of interface data. Length is 8-bits;							
11	DB4	and twice, thru DB4~DB7 in the case of interface data length							
12	DB5	is 4-bits. Upper four bits first then lower four bits.							
13	DB6								
14	DB7								
15	LED-(K)	I ED nower supply terminals							
16	LED+(A)	LED power supply terminals.							

6. PCB DRAWING AND DESCRIPTION



Note: The part no. DEM16102 is printed on the PCB.

DESCRIPTION:

6-1-1. The polarity of the pin 15 and the pin 16:

J3.J5	J2, J4	LED Polarity				
13,13	J <i>Z</i> , J4	15 Pin	16 Pin			
Each open	Each closed	Anode	Cathode			
Each closed	Each open	Cathode	Anode			

Note: In application module, J3=J5=close and J2=J4=open.

6-1-2. The metal-bezel should be on ground when the J1 is Solder-Bridge.

Note: In application module, J1 is closed.

6-1-3. The LED resistor should be bridged when the J6 is Solder-Bridge.

Note: In application module, J6 is open.

6-1-4. The R7 and the R8 are the LED resistor.

Note: In application module R7=10 Ohm.

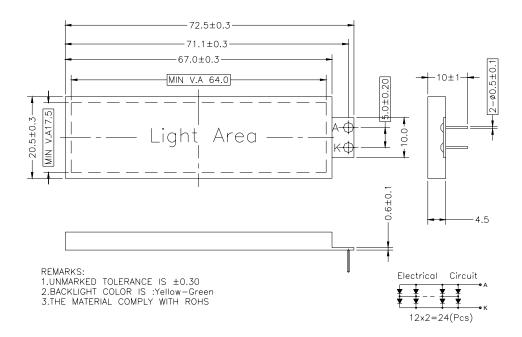
6-1-5. The mounting holes are set to ground when J7 is closed:

Note: In application module J7=closed.

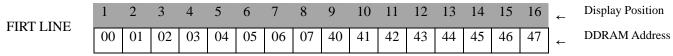
7. BACKLIGHT VOLTAGE & CURRENT (Ta=-20~+70°C)

	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS
Forward Voltage	Vf		4.2	4.6	V	$I_f = 150 \text{mA}$
Forward Current	Ιf		150	240	mA	
Power Dissipation	Pd		0.63		W	$I_f = 150 \text{mA}$
Reverse Voltage	VR		10.0		V	
Reverse Current	ΙR		0.200		mA	
Luminous Intensity	Įν	100	150		cd/m ²	$I_f = 150 \text{mA}$
Emission Wavelength	Èįė	569	572	575	nm	$I_f = 10 \text{ mA}$
Spectral Range	△Èë		30		nm	Ta=25°C

	SYMBOL	RATINGS
Operating Temperature	Topr	-20°C to +70°C
operating remperature	Tsty	-30°C to +80°C



8. DISPLAY DATA RAM (DDRAM)



When the display shift operation is performed, the DDRAM Address moved as follow:

After the left shift instruction

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	←	Display Position
01	02	03	04	05	06	07	08	41	42	43	44	45	46	47	48	←	DDRAM Address

After the right shift instruction

	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	←	Display Position
Ī	27	00	01	02	03	04	05	06	67	40	41	42	43	44	45	46	←	DDRAM Address

9.MAXIMUM ABSOLUTE POWER RATINGS (Ta=25°C)

Item	Symbol	Standard value	Unit
Power supply voltage (1)	V_{DD}	-0.3~+7.0	V
Power supply voltage (2)	V_{LCD}	V _{DD} -15.0~V _{DD} +0.3	V
Input voltage	V_{IN}	-0.3~V _{DD} +0.3	V
V _{Olt} . For BL	V_{LED1}	4~4.5	V
Operating temperature	Topr	-20~+70	°C
Storage temperature	Tstg	-25~+75	$^{\circ}$ C

^{*}Voltage greater than above may damage to the Circuit.

VDD > V1 > V2 > V3 > V4 > V5

10. ELECTRICAL CHARACTERISTICS

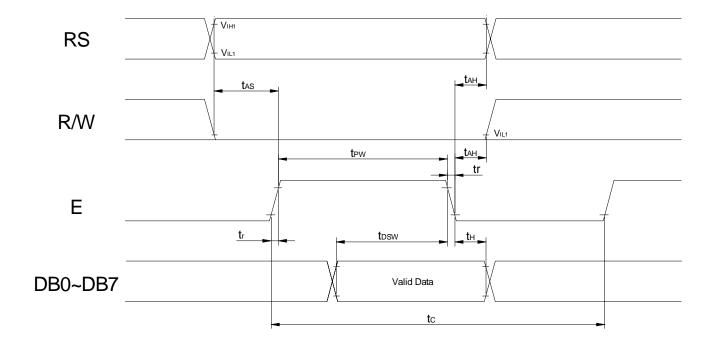
10-1 DC Characteristics (V_{DD} =4.5V~5.5V,Ta=-20~+70°C)

Item	Symbol	Sta	andard Va	lue	Test	Unit	
Item	Symbol	MIN	TYP	MAX	Condition		
Operating Voltage	$V_{ m DD}$	4.5	5	5.5		V	
Supply Current	I_{DD}		0.35	0.6	VDD=5V,fosc=270kHz	mA	
LCD Driving Voltage	VLCD	3.0	4.5	13.0	V_{DD} - V_0	V	

10-2 AC Characteristics (V_{DD} =4.5V~5.5V , Ta=-20~+70°C)

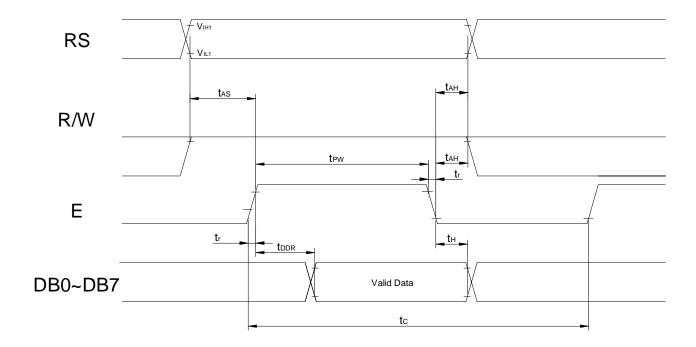
10-2-1 Write mode (writing data from MPU to ST7066)

Characteristic	Symbol	Min	Туре	Max	Unit	Test PIN
E Cycle Time	t _C	1200			ns	E
E Rise Time	t _R	-		25	ns	E
E Fall Time	t _F			25	ns	E
E Pulse width (High,Low)	t _W	140			ns	E
R/W and RS Set-up Time	t _{SU1}	0			ns	R/W,RS
R/W and RS Hold Time	t _{H1}	10			ns	R/W,RS
Data Set-up Time	t _{SU2}	40			ns	DB0~DB7
Data Hold Time	t _{H2}	10			ns	DB0~DB7



10-2-2 Read mode (reading data from ST7066 to MPU)

Characteristic	Symbol	Min	Туре	Max	Unit	Test PIN	
E Cycle Time	t _C	1200			ns	E	
E Rise Time	t _R			25	ns	E	
E Fall Time	t_{F}			25	ns	E	
E Pulse width (High, Low)	t _W	140			ns	E	
R/W and RS Set-up Time	t _{SU}	0			ns	R/W,RS	
R/W and RS Hold Time	t _H	10			ns	R/W,RS	
0Data Output Delay Time	t _D			120	ns	DB0~DB7	
Data Hold Time	t _{DH2}	10			ns	DB0~DB7	



11. CONTROL AND DISPLAY COMMAND

Command	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Executi on time (fosc=2 70KHz)	Remark		
Clear Display	0	0	0	0	0	0	0	0	0	1	1.52ms	Write"20H" to DDRAM. And set DDRAM address to "00H" from AC		
Return home	0	0	0	0	0	0	0	0	1	x	1.52ms	Set DDRAM address to "00H" from AC and return cursor to its original position if shifted. The contents of DDRAM are not changed.		
Entry mode Set	0	0	0	0	0	0	0	1	I/D	s	37us	Sets cursor move direction and specifies display shift. These operations are performed during data write and read.		
Display on/off control	0	0	0	0	0	0	1	D	O	В	37us	D=1: entire display on C=1: cursor on B=1: cursor position on		
Cursor or Display Shift	0	0	0	0	0	1	S/C	R/L	x	x	37us	Set cursor moving and display shift control bit, and the direction, without changing DDRAM data.		
function Set	0	0	0	0	1	DL	N	F	x	x	37us	DL: interface data is 8/4 bits N: number of line is 2/1 F: font size is 5x11/5x8		
Set CGRAM address	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	37us	Set CGRAM address in address counter		
Set DDRAM address	0	0	1	AC6	AC5	AC4	AC3	AC2	AC1	AC0	37us	Set DDRAM address in address counter		
Read busy flag& address	0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0	0us	Whether during internal operation or not can be known by reading BF. The contents of address counter can also be read.		
Write data to RAM	1	0	D7	D6	D5	D4	D3	D2	D1	D0	37us	Write data into internal RAM (DDRAM/CGRAM)		
Read data from RAM	1	1	D7	D6	D5	D4	D3	D2	D1	D0	37us	Read data from internal RAM (DDRAM / CGRAM)		

Note:

Be sure the ST7066U is not in the busy state (BF=00 before sending an instruction from the MPU to the ST7066U. If an instruction is sent without checking the busy flag, the time between the first instruction and next instruction will take much longer than the instruction time itself. Refer to instruction table for the list of each instruction execution time.

12. STANDARD CHARACTER PATTERN(ST7066U-0A-B)

Upper(4bit)	0000	0001	0010	0011	0100	0101	0110	0111	1000	1001	10010	1011	1100	1101	1110	1111
Lowerr(4bit) 0000	CG RAM (1)															
0001	(2)															
0010	(3)															
0011	(4)															
0100	(5)															
0101	(6)															
0110	(7)															
0111	(8)															
1000	(1)															
1001	(2)															
1010	(3)															
1011	(4)															
1100	(5)															
1101	(6)															
1110	(7)															
1111	(8)															

Version: 1

13. LCD MODULES HANDLING PRECAUTIONS

- Please remove the protection foil of polarizer before using.
- The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- If the display panel is damaged and the liquid crystal substance inside it leaks out, do not get any in your mouth. If the substance come into contact with your skin or clothes promptly wash it off using soap and water.
- Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarize carefully.
- To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - -Be sure to ground the body when handling the LCD module.
 - -Tools required for assembly, such as soldering irons, must be properly grounded.
 - -To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
 - -The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.

Storage precautions

When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps. Keep the modules in bags designed to prevent static electricity charging under low temperature / normal humidity conditions (avoid high temperature / high humidity and low temperatures below 0°C). Whenever possible, the LCD modules should be stored in the same conditions in which they were shipped from our company.

14. OTHERS

- Liquid crystals solidify at low temperature (below the storage temperature range) leading to defective orientation of liquid crystal or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subjected to a strong shock at a low temperature.
- If the LCD modules have been operating for a long time showing the same display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. Abnormal operating status can be resumed to be normal condition by suspending use for some time. It should be noted that this phenomena does not adversely affect performance reliability.
- To minimize the performance degradation of the LCD modules resulting from caused by static electricity, etc. exercise care to avoid holding the following sections when handling the modules:
 - Exposed area of the printed circuit board
 - Terminal electrode sections